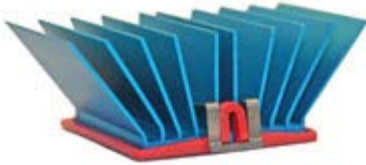


BGA Heat Sink - High Performance maxiFLOW/superGRIP



ATS Part#: **ATS-X50270G-C1-R0**
Description: 27.00 x 27.00 x 12.50 mm BGA Heat Sink - High Performance maxiFLOW/superGRIP

Heat Sink Type: **maxiFLOW**
Heat Sink Attachment: **superGRIP**
Equivalent Part Number: **N/A**

**Image above is for illustration purpose only.*

Features & Benefits

- Designed for 27 x 27 mm components
- Requires minimal space around the component's perimeter; ideal for densely populated PCBs
- Allows the heat sink to be detached and reattached without damaging the component or the PCB, an important feature in the event a PCB may need to be reworked
- Strong, uniform attachment force helps achieve maximum performance from phase-changing TIMs
- Eliminates the need to drill mounting holes in the PCB

Thermal Performance

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	4.8 °C/W	3.9 °C/W	3.4 °C/W	3 °C/W	2.8 °C/W	2.6 °C/W	2.4 °C/W
	Ducted Flow	3.8	N/A	N/A	N/A	N/A	N/A	N/A

Product Detail

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	TIM	Finish
	27.00 mm	27.00 mm	12.50 mm	48.3 mm	T766	BLUE-ANODIZED
Notes: • Dimension A and B refer to component size. • Dimension C is the heat sink height from the bottom of the base to the top of the fin field. • Thermal performance data are provided for reference only. Actual performance may vary by application. • ATS reserves the right to update or change its products without notice to improve the design or performance. • ATS certifies that this heat sink assembly is RoHS-6 and REACH compliant. • Contact ATS to learn about custom options available.						

**Image above is for illustration purpose only.*

For more information, to find a distributor or to place an order, please contact us at 781-769-2800 (North America), sales@qats.com or www.qats.com.

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